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(12)

United States Design Patent
Iwasaki et al.

(10)

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(45)

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(54) **SEMICONDUCTOR DEVICE**

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(73) Assignee: **Mitsubishi Denki Kabushiki Kaisha**, Tokyo (JP)

(**) Term: **14 Years**

(21) Appl. No.: **29/156,527**

(22) Filed: **Mar. 4, 2002**

(30) **Foreign Application Priority Data**

Nov. 30, 2001 (JP) 2001-035252

(51) **LOC (7) Cl.** **13-03**

(52) **U.S. Cl.** **D13/182**

(58) **Field of Search** D13/158; 174/16.3, 174/52.1, 52.2, 52.4; 257/670, 672, 676, 686, 688, 690–696, 703, 787; 361/736, 742, 748, 752, 760, 761, 774, 783, 784, 785, 798, 813, 820

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(57) **CLAIM**

The ornamental design for a semiconductor device, as shown and described.

DESCRIPTION

FIG. 1 is a front, top and right side perspective view of a semiconductor device, showing our new design;

FIG. 2 is a rear, bottom and left side perspective view thereof;

FIG. 3 is a front elevational view thereof;

FIG. 4 is a rear elevational view thereof;

FIG. 5 is a top plan view thereof;

FIG. 6 is a bottom plan view thereof;

FIG. 7 is a left side elevational view thereof;

FIG. 8 is a right side elevational view thereof; and,

FIG. 9 is a cross-sectional view thereof, taken along line 9—9 of FIG. 3, with the internal system omitted.

1 Claim, 4 Drawing Sheets

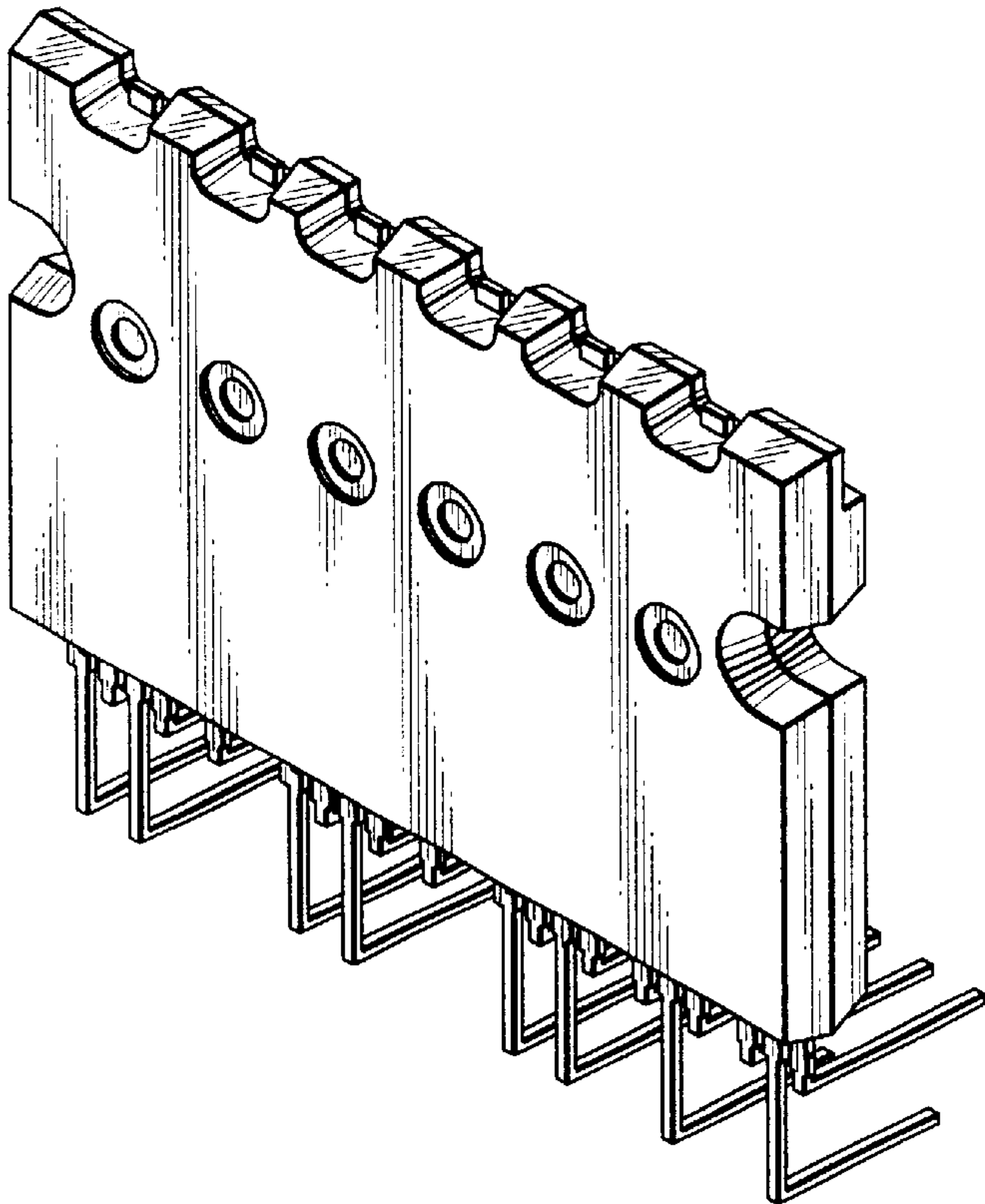


FIG.1

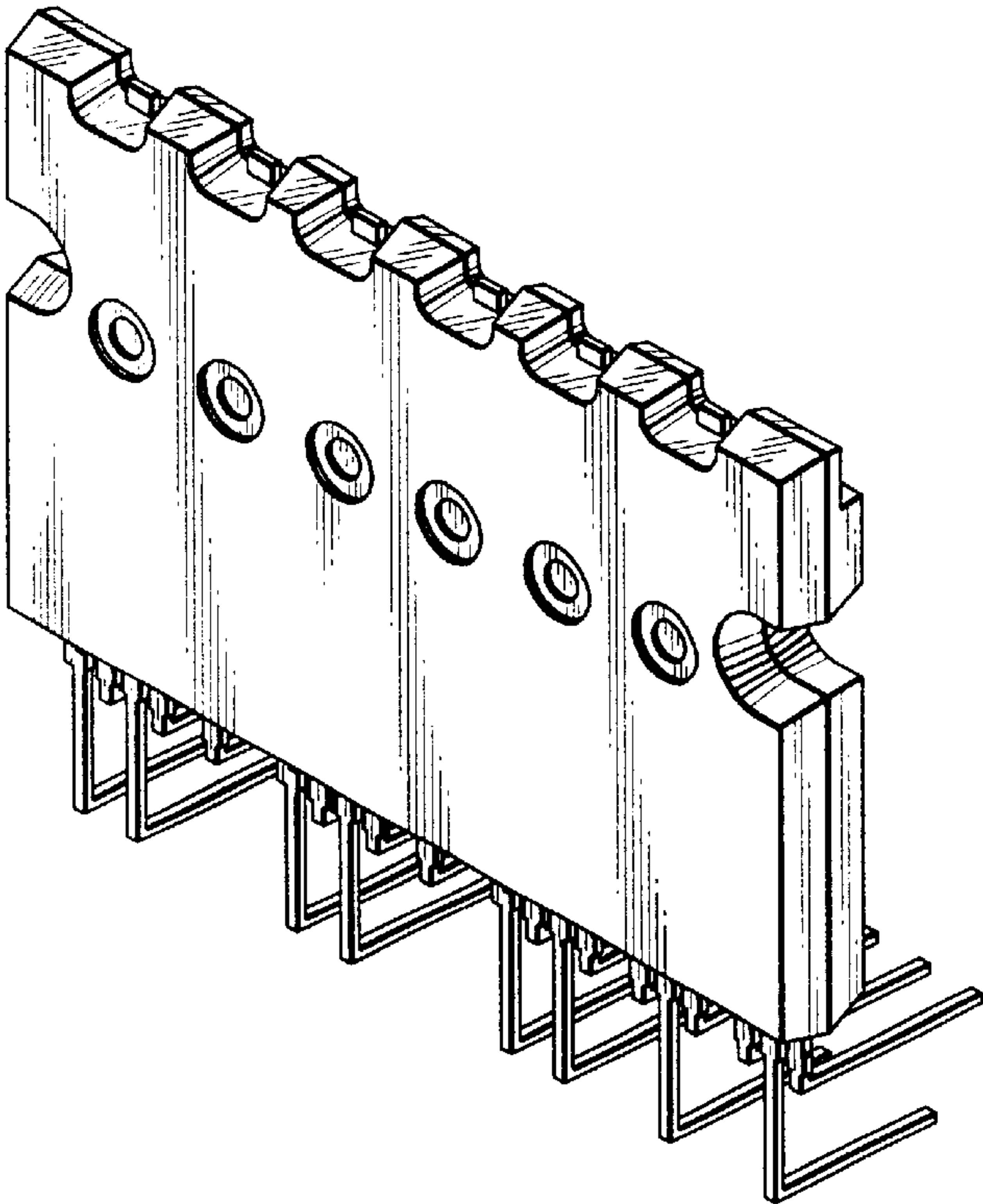


FIG.2

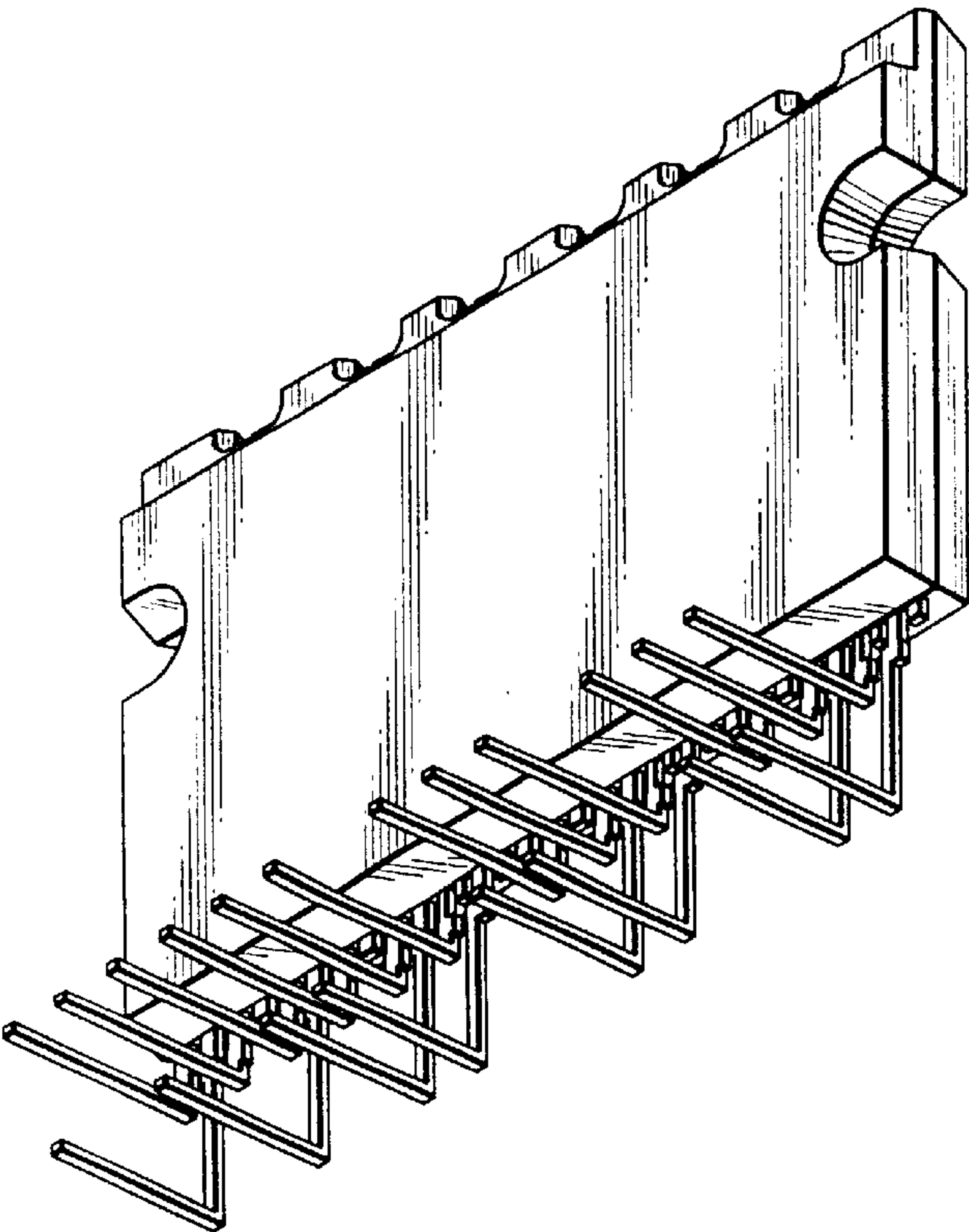


FIG.3

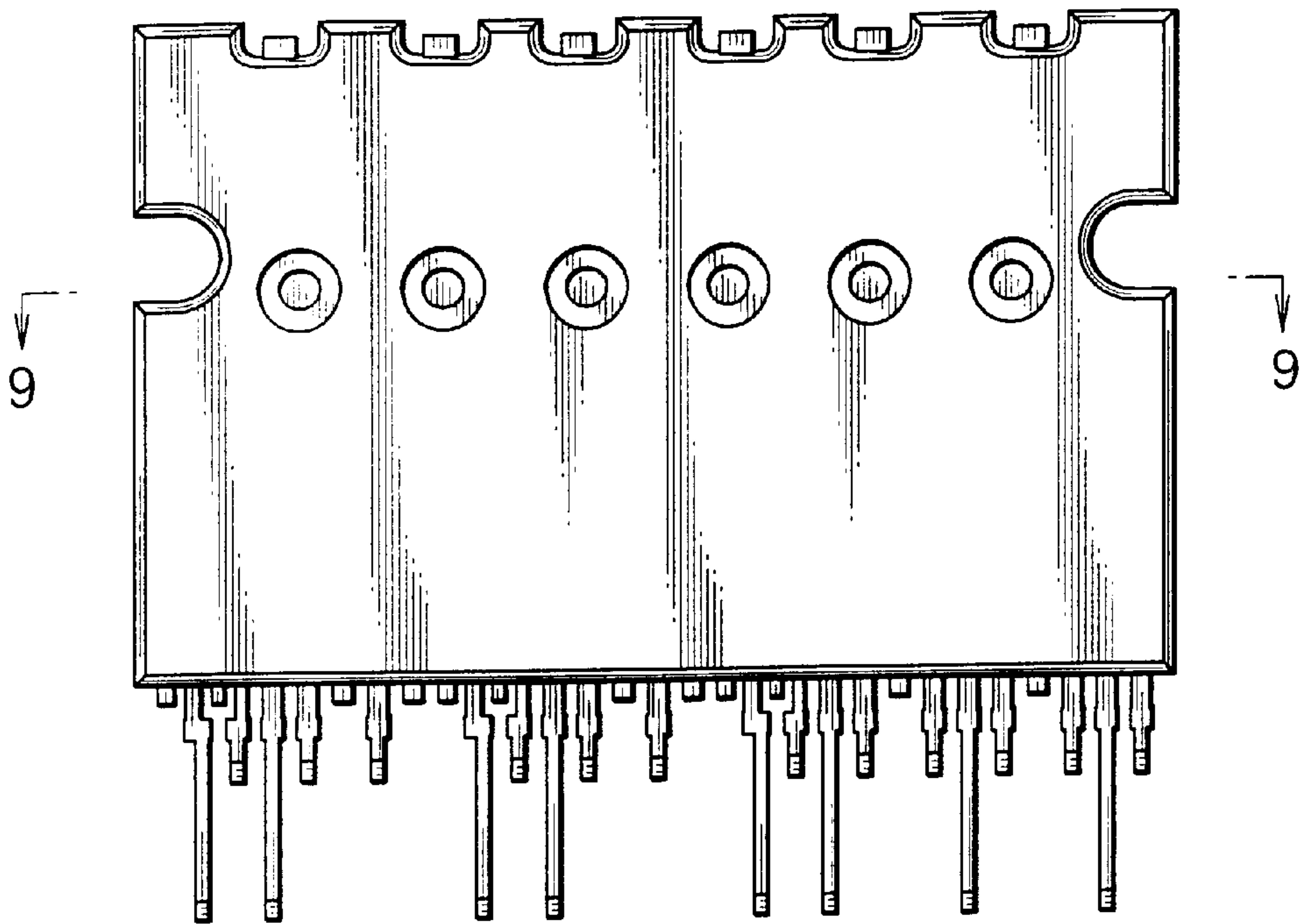


FIG.4

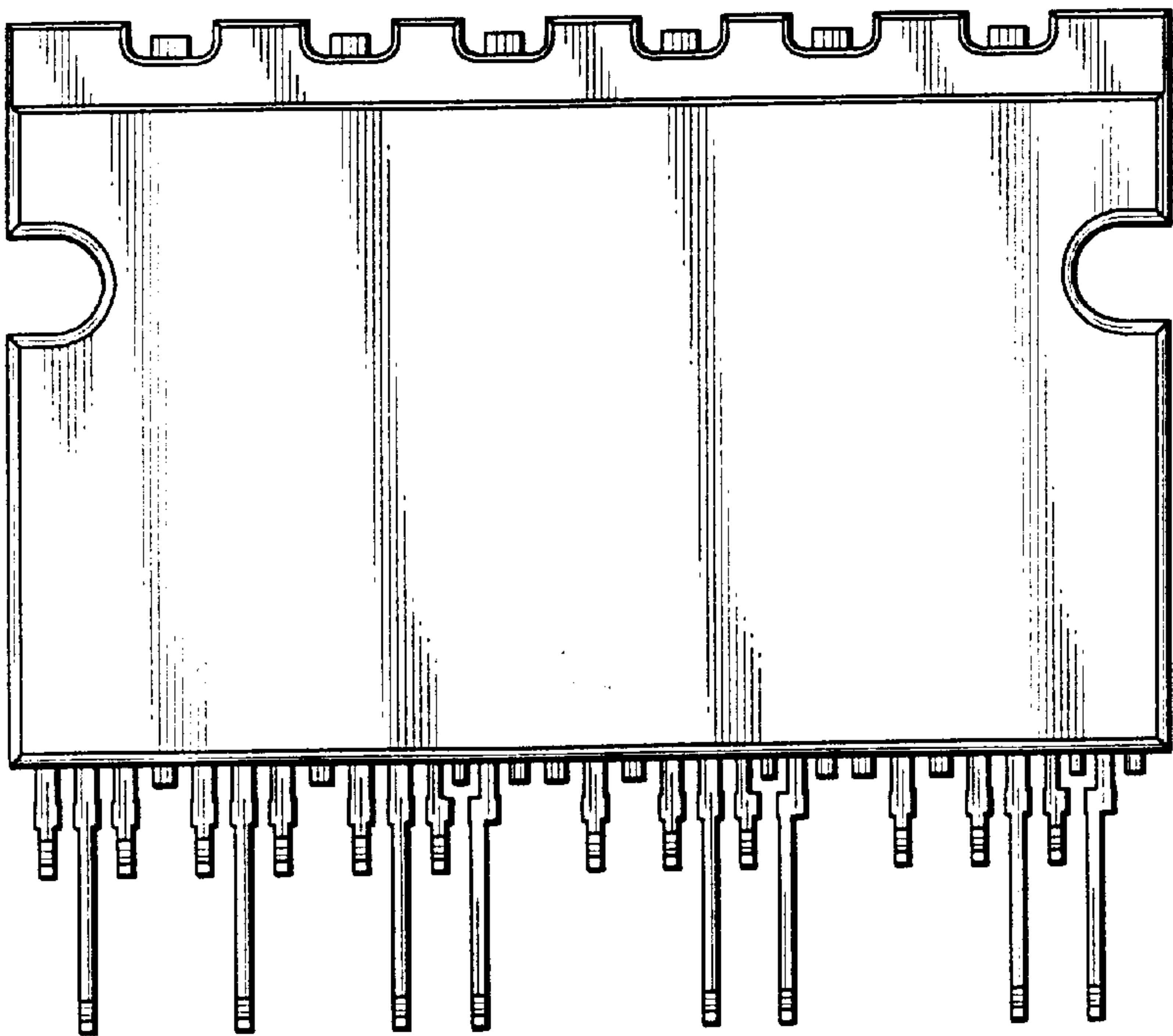


FIG.5

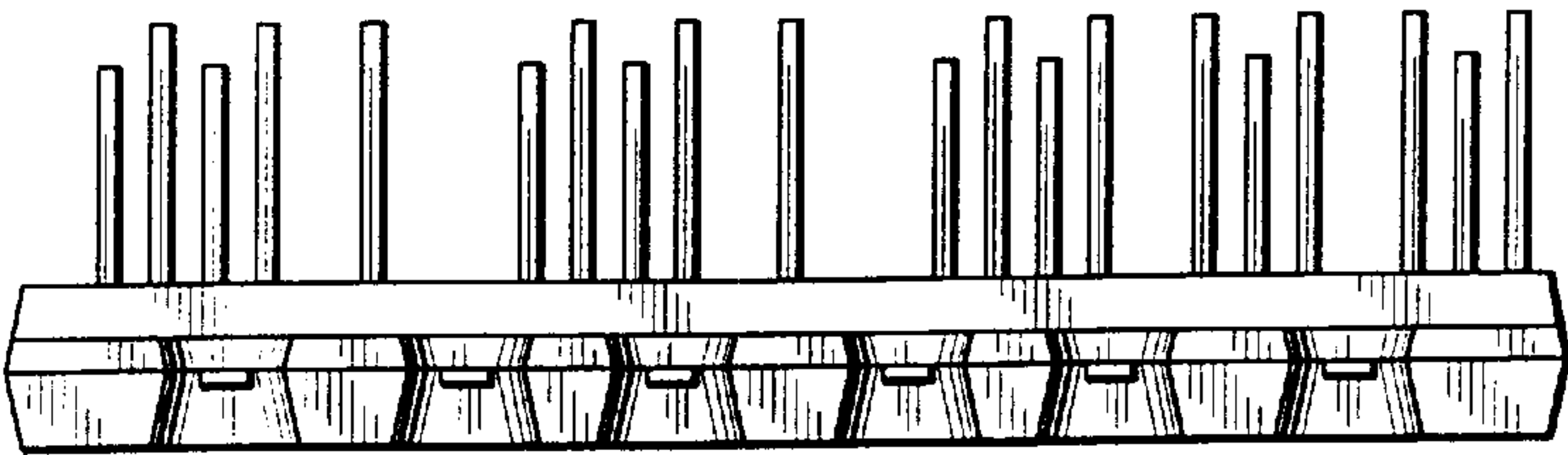


FIG.6

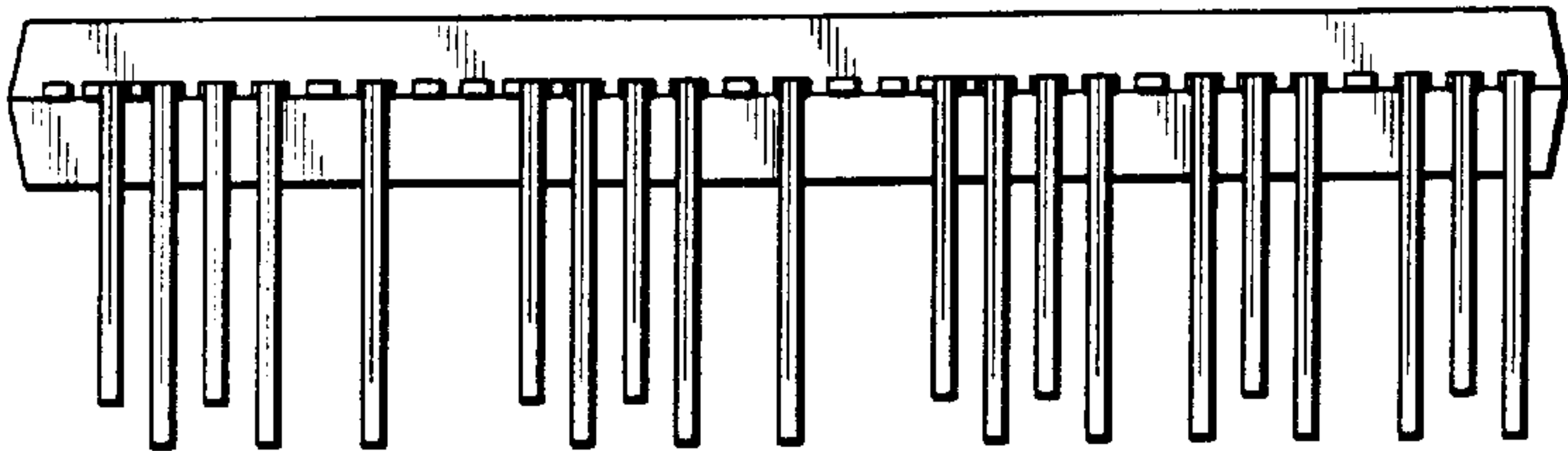


FIG.7

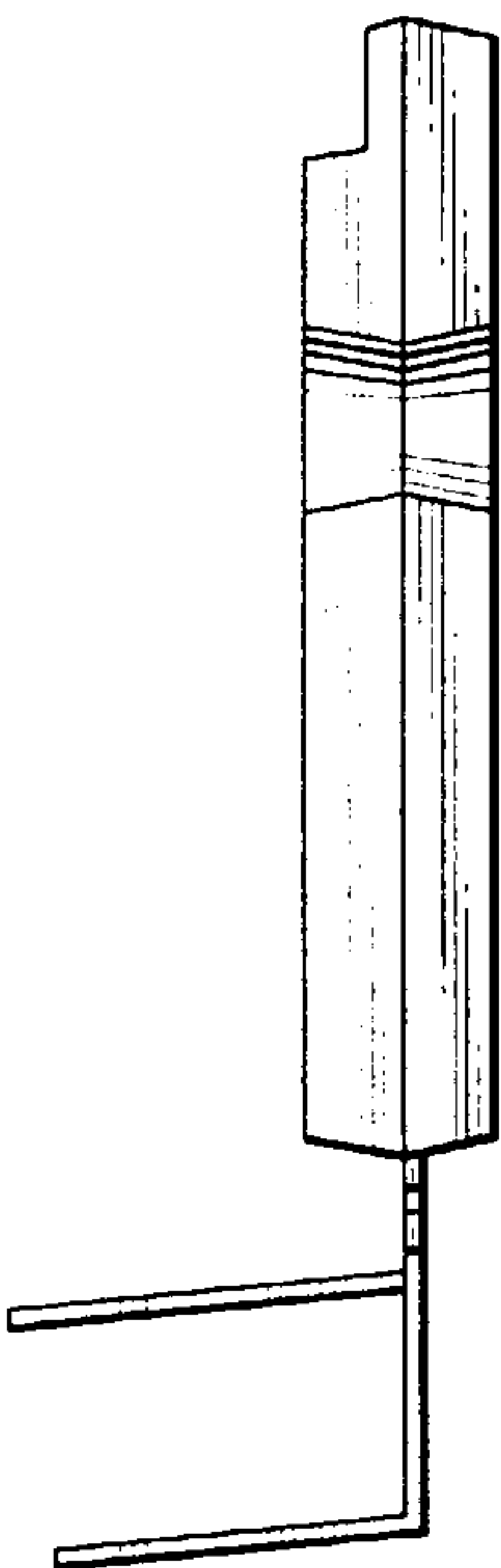


FIG.8

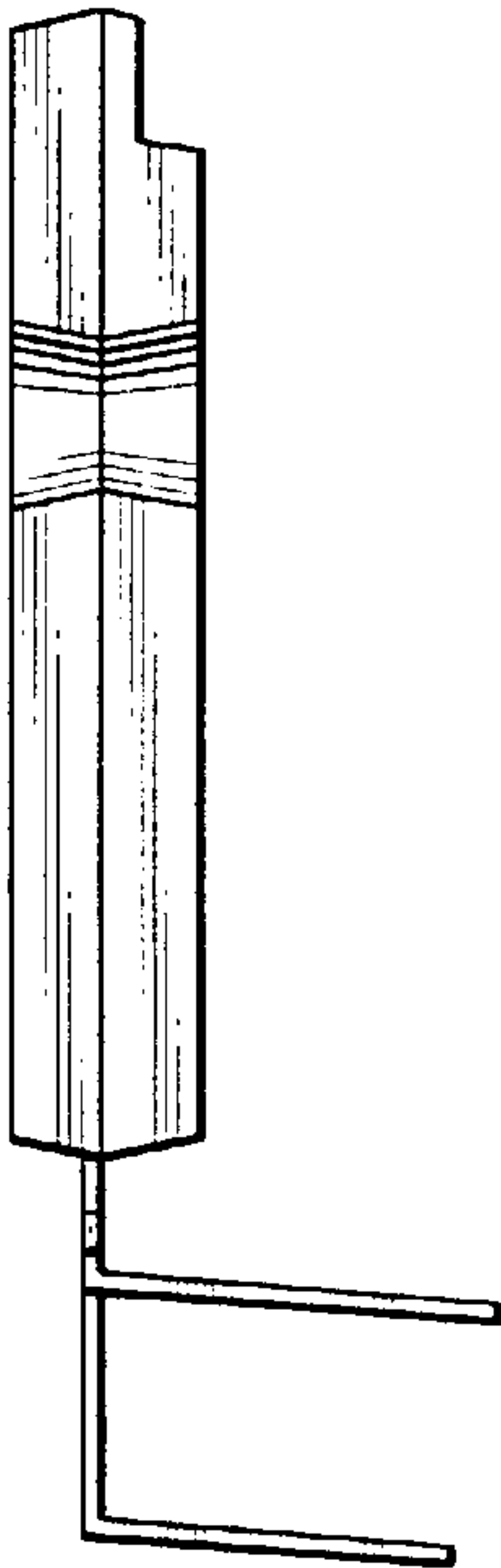


FIG.9

